

Heterojunction Bipolar Transistor (InGaP HBT)

Broadband High Linearity Amplifier

The MMG3011NT1 is a general purpose amplifier that is internally input and output matched. It is designed for a broad range of Class A, small-signal, high linearity, general purpose applications. It is suitable for applications with frequencies from 0 to 6000 MHz such as cellular, PCS, BWA, WLL, PHS, CATV, VHF, UHF, UMTS and general small-signal RF.

Features

- Frequency: 0 to 6000 MHz
- P1dB: 15 dBm @ 900 MHz
- Small-Signal Gain: 15 dB @ 900 MHz
- Third Order Output Intercept Point: 28 dBm @ 900 MHz
- Single 5 V Supply
- Internally Matched to 50 Ohms
- Cost-effective SOT-89 Surface Mount Plastic Package
- In Tape and Reel. T1 Suffix = 1,000 Units, 12 mm Tape Width, 7-inch Reel.

MMG3011NT1

**0-6000 MHz, 15 dB
15 dBm
InGaP HBT GPA**



SOT-89

Table 1. Typical Performance (1)

| Characteristic | Symbol | 900 MHz | 2140 MHz | 3500 MHz | Unit |
|------------------------------------|----------------|---------|----------|----------|------|
| Small-Signal Gain (S21) | G _p | 15 | 14 | 12 | dB |
| Input Return Loss (S11) | IRL | -18 | -25 | -25 | dB |
| Output Return Loss (S22) | ORL | -25 | -18 | -17 | dB |
| Power Output @1dB Compression | P1dB | 15 | 13.5 | 13.5 | dBm |
| Third Order Output Intercept Point | OIP3 | 28 | 26.5 | 26 | dBm |

1. V_{CC} = 5 Vdc, T_A = 25°C, 50 ohm system.

Table 2. Maximum Ratings

| Rating | Symbol | Value | Unit |
|---------------------------|------------------|-------------|------|
| Supply Voltage | V _{CC} | 6 | V |
| Supply Current | I _{CC} | 80 | mA |
| RF Input Power | P _{in} | 10 | dBm |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Junction Temperature | T _J | 150 | °C |

Table 3. Thermal Characteristics

| Characteristic | Symbol | Value (2) | Unit |
|--|------------------|-----------|------|
| Thermal Resistance, Junction to Case Case Temperature 87°C, 5 Vdc, 41 mA, no RF applied | R _{θJC} | 83 | °C/W |

2. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>.
Select Documentation/Application Notes - AN1955.

Table 4. Electrical Characteristics ($V_{CC} = 5 \text{ Vdc}$, 900 MHz, $T_A = 25^\circ\text{C}$, 50 ohm system, in Freescale Application Circuit)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|------------------------------------|----------|------|-----|-----|------|
| Small-Signal Gain (S21) | G_p | 13.5 | 15 | — | dB |
| Input Return Loss (S11) | IRL | — | -18 | — | dB |
| Output Return Loss (S22) | ORL | — | -25 | — | dB |
| Power Output @ 1dB Compression | P1dB | — | 15 | — | dBm |
| Third Order Output Intercept Point | OIP3 | — | 28 | — | dBm |
| Noise Figure | NF | — | 4.6 | — | dB |
| Supply Current | I_{CC} | 32 | 41 | 48 | mA |
| Supply Voltage | V_{CC} | — | 5 | — | V |

Table 5. Functional Pin Description

| Pin Number | Pin Function |
|------------|----------------------|
| 1 | RF_{in} |
| 2 | Ground |
| 3 | RF_{out}/DC Supply |

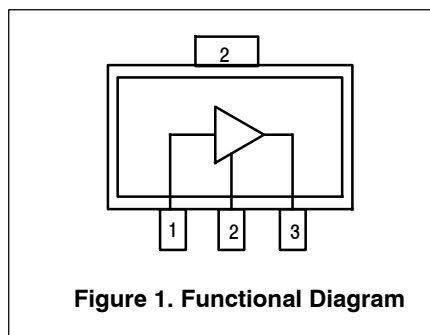


Figure 1. Functional Diagram

Table 6. ESD Protection Characteristics

| Test Methodology | Class |
|--|-------|
| Human Body Model (per JESD 22-A114) | 1A |
| Machine Model (per EIA/JESD 22-A115) | A |
| Charge Device Model (per JESD 22-C101) | IV |

Table 7. Moisture Sensitivity Level

| Test Methodology | Rating | Package Peak Temperature | Unit |
|---------------------------------------|--------|--------------------------|------------------|
| Per JESD 22-A113, IPC/JEDEC J-STD-020 | 1 | 260 | $^\circ\text{C}$ |

50 OHM TYPICAL CHARACTERISTICS

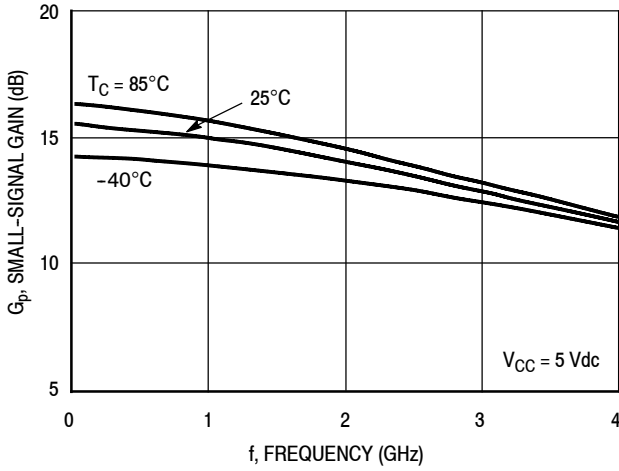


Figure 2. Small-Signal Gain (S21) versus Frequency

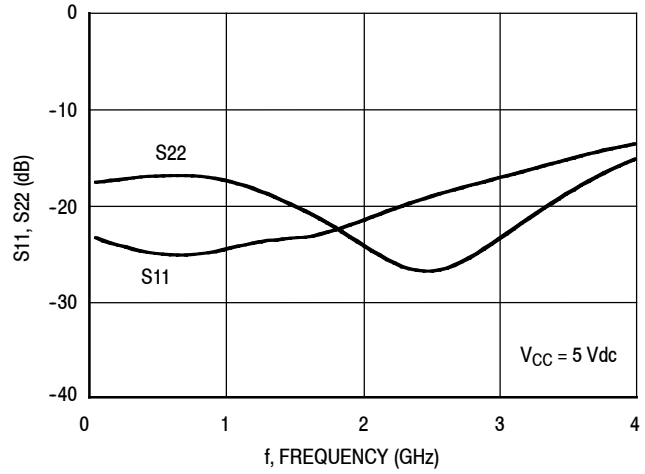


Figure 3. Input/Output Return Loss versus Frequency

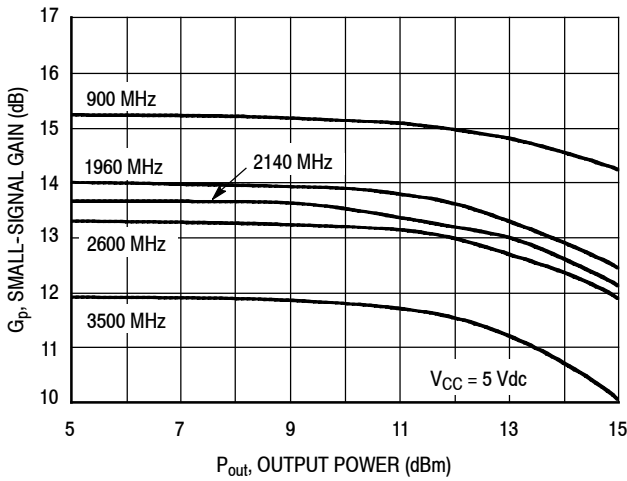


Figure 4. Small-Signal Gain versus Output Power

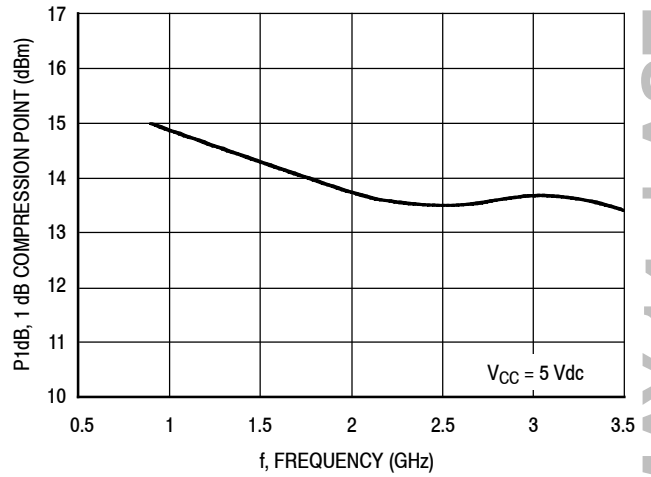


Figure 5. P1dB versus Frequency

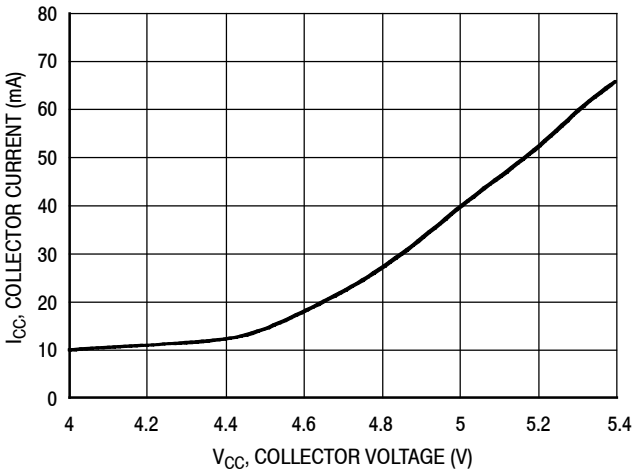


Figure 6. Collector Current versus Collector Voltage

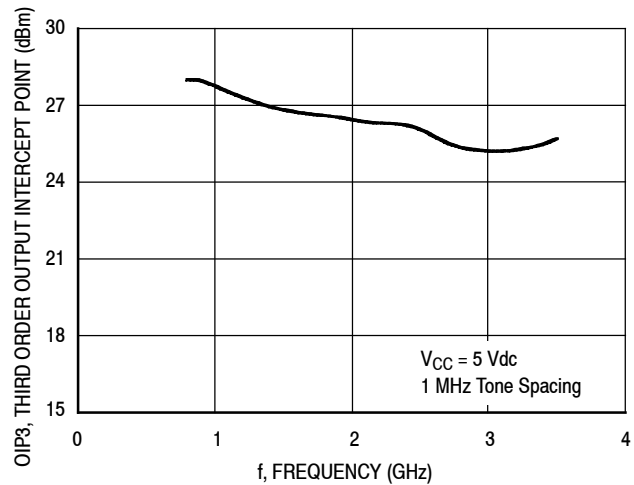


Figure 7. Third Order Output Intercept Point versus Frequency

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15

50 OHM TYPICAL CHARACTERISTICS

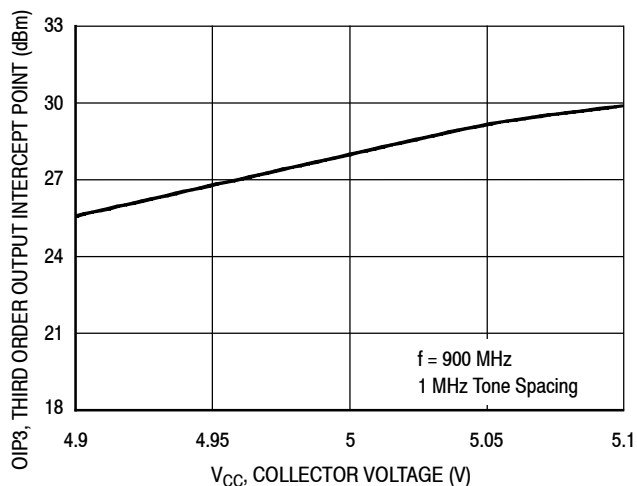


Figure 8. Third Order Output Intercept Point versus Collector Voltage

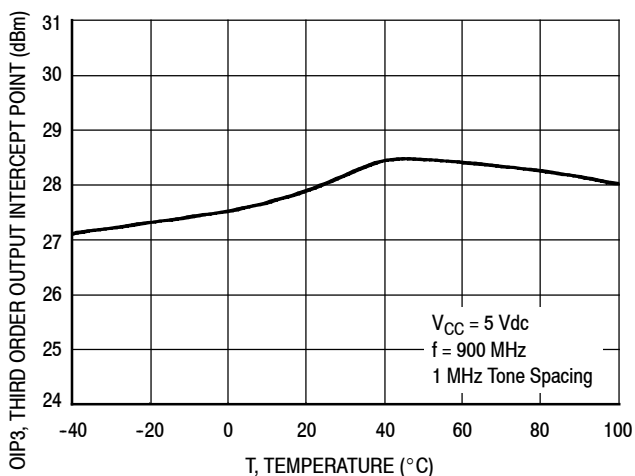


Figure 9. Third Order Output Intercept Point versus Case Temperature

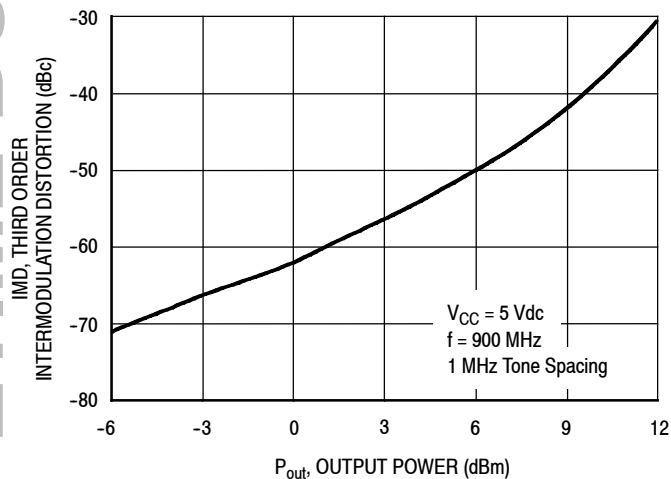


Figure 10. Third Order Intermodulation Distortion versus Output Power

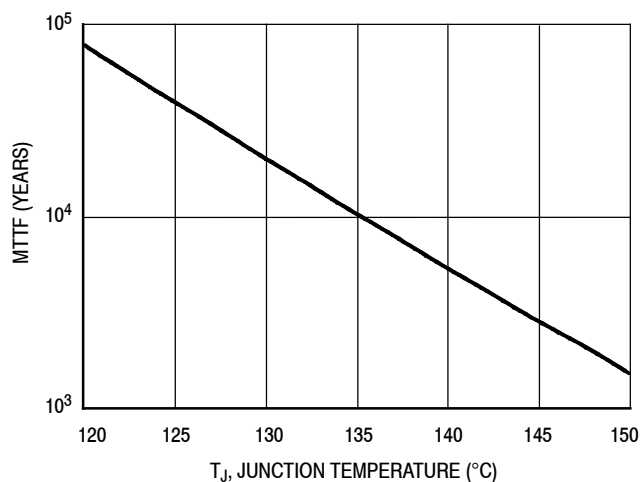


Figure 11. MTTF versus Junction Temperature

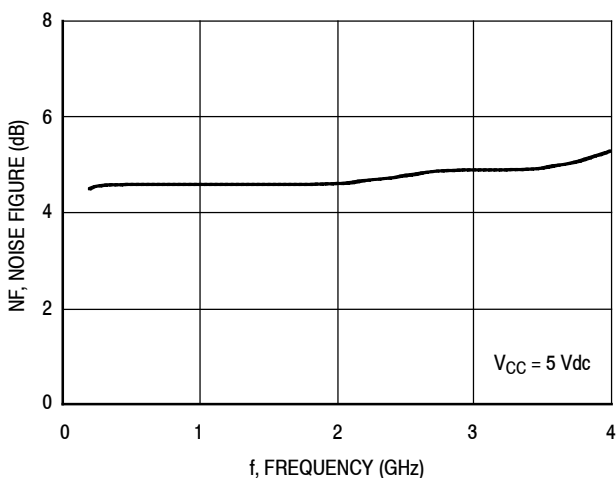


Figure 12. Noise Figure versus Frequency

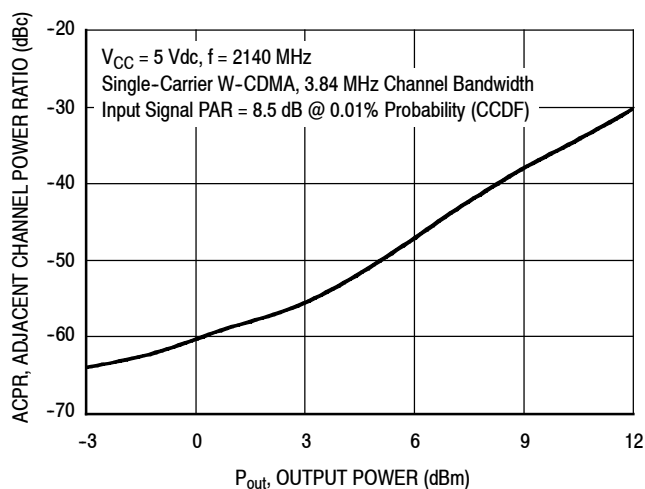


Figure 13. Single-Carrier W-CDMA Adjacent Channel Power Ratio versus Output Power

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15

50 OHM APPLICATION CIRCUIT: 40-300 MHz

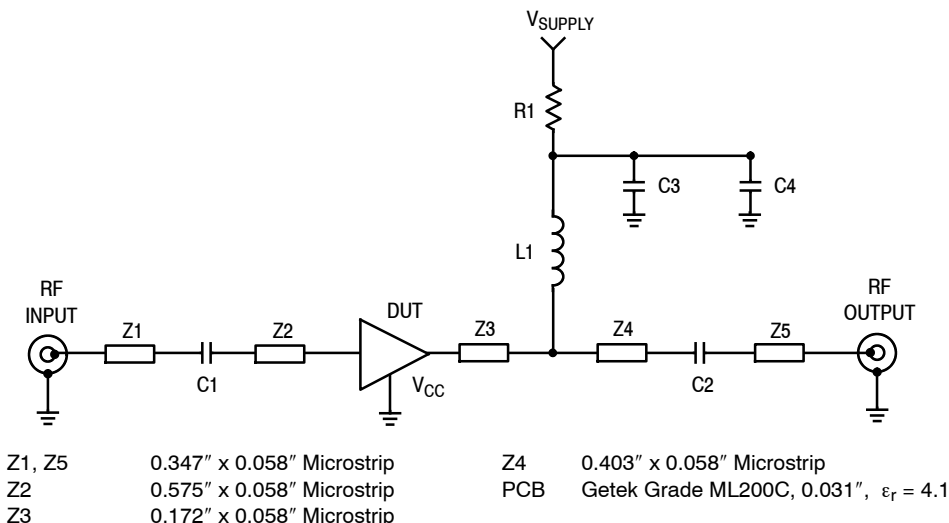


Figure 14. 50 Ohm Test Circuit Schematic

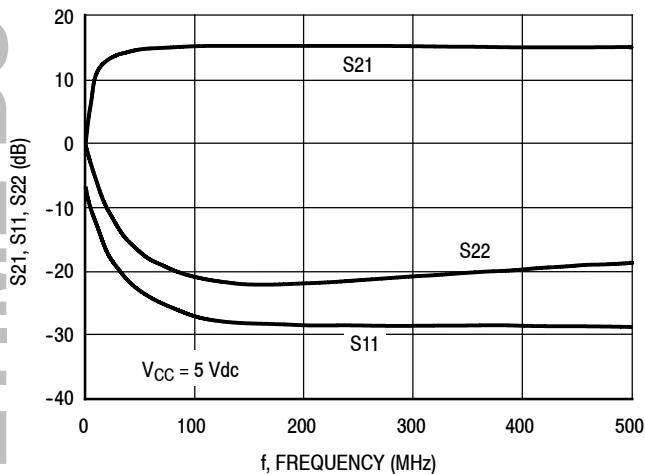


Figure 15. S21, S11 and S22 versus Frequency

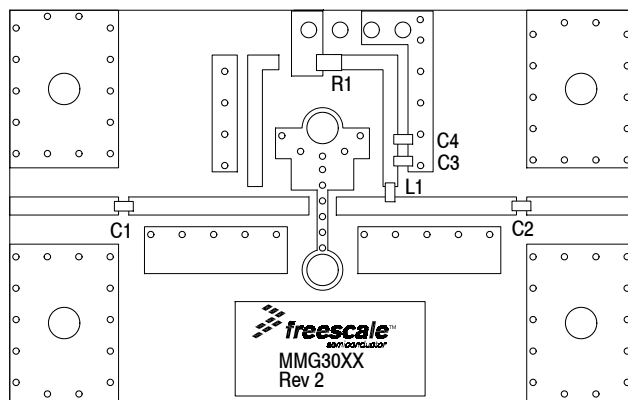


Figure 16. 50 Ohm Test Circuit Component Layout

Table 8. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|------------|------------------------------|----------------|--------------|
| C1, C2, C3 | 0.01 μ F Chip Capacitors | C0603C103J5RAC | Kemet |
| C4 | 1000 pF Chip Capacitor | C0603C102J5RAC | Kemet |
| L1 | 470 nH Chip Inductor | BK2125HM471-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15

50 OHM APPLICATION CIRCUIT: 300-3600 MHz

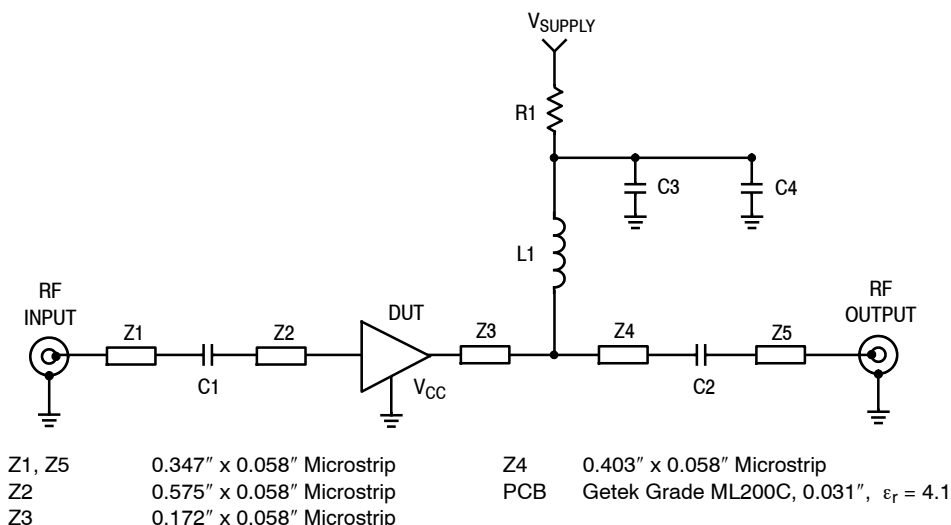


Figure 17. 50 Ohm Test Circuit Schematic

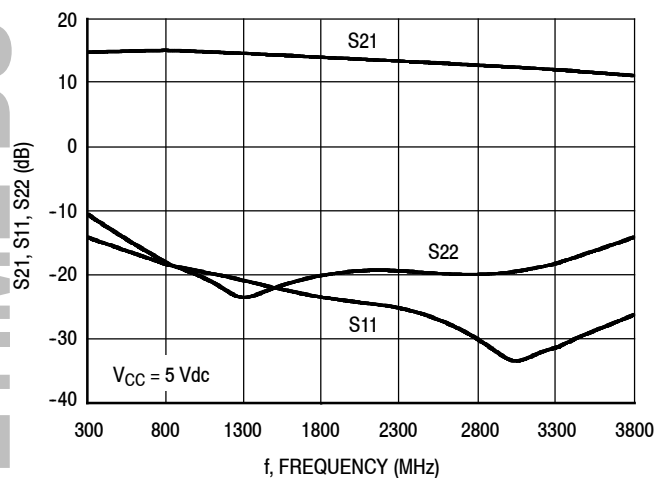


Figure 18. S21, S11 and S22 versus Frequency

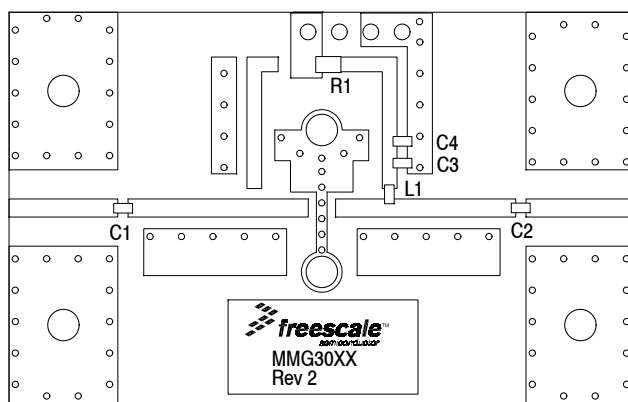


Figure 19. 50 Ohm Test Circuit Component Layout

Table 9. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|--------|-----------------------------|----------------|--------------|
| C1, C2 | 150 pF Chip Capacitors | C0603C151J5RAC | Kemet |
| C3 | 0.01 μ F Chip Capacitor | C0603C103J5RAC | Kemet |
| C4 | 1000 pF Chip Capacitor | C0603C102J5RAC | Kemet |
| L1 | 56 nH Chip Inductor | HK160856NJ-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15

50 OHM TYPICAL CHARACTERISTICS

Table 10. Common Emitter S-Parameters ($V_{CC} = 5 \text{ Vdc}$, $T_A = 25^\circ\text{C}$, 50 Ohm System)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|---------|-----------------|---------|-----------------|---------|-----------------|----------|
| | S ₁₁ | ∠ φ | S ₂₁ | ∠ φ | S ₁₂ | ∠ φ | S ₂₂ | ∠ φ |
| 100 | 0.06552 | 170.033 | 5.96942 | 176.263 | 0.09975 | -0.816 | 0.13385 | -2.955 |
| 150 | 0.06383 | 167.931 | 5.93739 | 174.155 | 0.09991 | -1.18 | 0.13500 | -4.514 |
| 200 | 0.06269 | 165.117 | 5.91539 | 171.527 | 0.10015 | -2.477 | 0.13601 | -6.374 |
| 250 | 0.06117 | 162.063 | 5.89348 | 169.546 | 0.10045 | -2.883 | 0.13724 | -9.6 |
| 300 | 0.05981 | 158.66 | 5.87619 | 167.518 | 0.10063 | -3.34 | 0.13832 | -12.707 |
| 350 | 0.05830 | 154.766 | 5.86975 | 165.398 | 0.10085 | -4.05 | 0.14046 | -14.848 |
| 400 | 0.05702 | 150.967 | 5.85785 | 163.377 | 0.10108 | -4.506 | 0.14191 | -17.031 |
| 450 | 0.05620 | 147.157 | 5.84533 | 161.303 | 0.10131 | -5.159 | 0.14371 | -19.568 |
| 500 | 0.05480 | 143.805 | 5.83028 | 159.19 | 0.10142 | -5.766 | 0.14461 | -21.523 |
| 550 | 0.05404 | 139.862 | 5.81371 | 157.192 | 0.10154 | -6.253 | 0.14562 | -23.875 |
| 600 | 0.05345 | 136.215 | 5.79406 | 155.172 | 0.10159 | -6.83 | 0.14624 | -25.878 |
| 650 | 0.05300 | 132.595 | 5.77608 | 153.133 | 0.10166 | -7.449 | 0.14664 | -28.005 |
| 700 | 0.05301 | 129.164 | 5.75924 | 151.135 | 0.10172 | -7.985 | 0.14651 | -30.174 |
| 750 | 0.05337 | 125.784 | 5.73951 | 149.108 | 0.10177 | -8.608 | 0.14648 | -32.244 |
| 800 | 0.05401 | 122.842 | 5.71885 | 147.093 | 0.10184 | -9.178 | 0.14551 | -34.496 |
| 850 | 0.05502 | 120.061 | 5.69616 | 145.064 | 0.10204 | -9.746 | 0.14435 | -36.557 |
| 900 | 0.05607 | 117.736 | 5.67188 | 143.066 | 0.10209 | -10.319 | 0.14281 | -38.707 |
| 950 | 0.05712 | 115.541 | 5.65082 | 141.112 | 0.10222 | -10.915 | 0.14087 | -40.982 |
| 1000 | 0.05849 | 113.614 | 5.62851 | 139.109 | 0.10236 | -11.506 | 0.13859 | -43.169 |
| 1050 | 0.06056 | 112.274 | 5.60006 | 137.159 | 0.10243 | -12.103 | 0.13641 | -45.576 |
| 1100 | 0.06216 | 111.255 | 5.57557 | 135.169 | 0.10254 | -12.71 | 0.13320 | -47.809 |
| 1150 | 0.06385 | 110.823 | 5.55100 | 133.202 | 0.10280 | -13.306 | 0.12952 | -50.265 |
| 1200 | 0.06581 | 110.396 | 5.52258 | 131.231 | 0.10297 | -13.892 | 0.12567 | -52.695 |
| 1250 | 0.06795 | 110.14 | 5.49787 | 129.289 | 0.10307 | -14.559 | 0.12169 | -55.267 |
| 1300 | 0.07029 | 110.037 | 5.47256 | 127.359 | 0.10327 | -15.203 | 0.11718 | -57.902 |
| 1350 | 0.06417 | 110.3 | 5.44429 | 125.432 | 0.10350 | -15.851 | 0.11263 | -60.543 |
| 1400 | 0.06615 | 110.33 | 5.41593 | 123.531 | 0.10367 | -16.46 | 0.10814 | -63.335 |
| 1450 | 0.06834 | 110.566 | 5.38670 | 121.627 | 0.10385 | -17.039 | 0.10311 | -66.301 |
| 1500 | 0.07037 | 111.203 | 5.35727 | 119.73 | 0.10409 | -17.682 | 0.09824 | -69.317 |
| 1550 | 0.06361 | 106.262 | 5.33305 | 117.89 | 0.10444 | -18.324 | 0.09725 | -65.446 |
| 1600 | 0.06510 | 104.31 | 5.30415 | 116 | 0.10462 | -18.939 | 0.09352 | -67.448 |
| 1650 | 0.06709 | 103.387 | 5.26958 | 114.125 | 0.10474 | -19.656 | 0.09017 | -69.038 |
| 1700 | 0.06871 | 101.77 | 5.24166 | 112.251 | 0.10505 | -20.294 | 0.08614 | -71.347 |
| 1750 | 0.07086 | 100.502 | 5.21283 | 110.413 | 0.10523 | -20.945 | 0.08224 | -73.345 |
| 1800 | 0.07328 | 99.404 | 5.18411 | 108.549 | 0.10547 | -21.577 | 0.07847 | -75.924 |
| 1850 | 0.07577 | 98.261 | 5.15395 | 106.674 | 0.10576 | -22.375 | 0.07419 | -78.51 |
| 1900 | 0.07845 | 97.17 | 5.12325 | 104.849 | 0.10592 | -23.012 | 0.07045 | -81.64 |
| 1950 | 0.08096 | 96.588 | 5.09284 | 102.996 | 0.10612 | -23.742 | 0.06627 | -85.166 |
| 2000 | 0.08378 | 95.835 | 5.06020 | 101.184 | 0.10637 | -24.419 | 0.06270 | -88.825 |
| 2050 | 0.08710 | 94.791 | 5.03015 | 99.346 | 0.10667 | -25.036 | 0.05860 | -93.023 |
| 2100 | 0.08957 | 94.206 | 5.00175 | 97.519 | 0.10686 | -25.835 | 0.05542 | -97.743 |
| 2150 | 0.09160 | 93.044 | 4.96977 | 95.715 | 0.10722 | -26.591 | 0.05191 | -103.413 |
| 2200 | 0.09580 | 92.472 | 4.93541 | 93.926 | 0.10725 | -27.253 | 0.04928 | -109.11 |
| 2250 | 0.09801 | 91.352 | 4.90425 | 92.125 | 0.10767 | -27.931 | 0.04677 | -115.508 |

(continued)

MMG3011NT1

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15

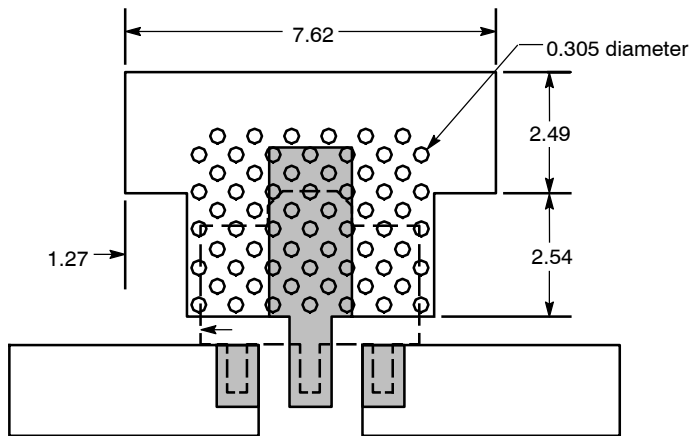
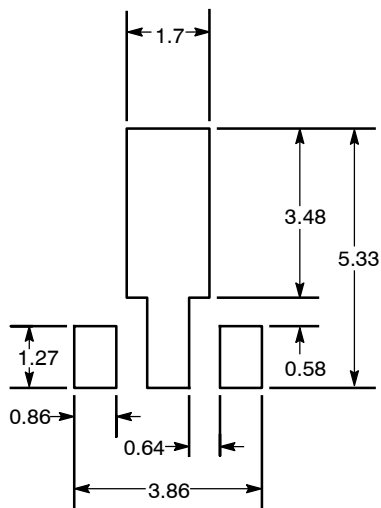
50 OHM TYPICAL CHARACTERISTICS

Table 10. Common Emitter S-Parameters ($V_{CC} = 5 \text{ Vdc}$, $T_A = 25^\circ\text{C}$, 50 Ohm System) (continued)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|--------|-----------------|--------|-----------------|---------|-----------------|----------|
| | S ₁₁ | ∠ φ | S ₂₁ | ∠ φ | S ₁₂ | ∠ φ | S ₂₂ | ∠ φ |
| 2300 | 0.10125 | 90.343 | 4.87215 | 90.327 | 0.10777 | -28.67 | 0.04452 | -122.296 |
| 2350 | 0.10384 | 89.16 | 4.84064 | 88.561 | 0.10817 | -29.394 | 0.04294 | -129.541 |
| 2400 | 0.10702 | 88.397 | 4.80597 | 86.77 | 0.10841 | -30.211 | 0.04205 | -138.1 |
| 2450 | 0.11008 | 87.519 | 4.77373 | 85.006 | 0.10869 | -30.924 | 0.04158 | -146.363 |
| 2500 | 0.11241 | 86.11 | 4.73852 | 83.289 | 0.10879 | -31.661 | 0.04157 | -154.578 |
| 2550 | 0.11540 | 85.045 | 4.71080 | 81.53 | 0.10916 | -32.408 | 0.04231 | -162.984 |
| 2600 | 0.11824 | 83.877 | 4.67765 | 79.803 | 0.10931 | -33.203 | 0.04340 | -171.06 |
| 2650 | 0.12090 | 82.346 | 4.64616 | 78.061 | 0.10958 | -33.929 | 0.04508 | -178.591 |
| 2700 | 0.12340 | 81.156 | 4.61372 | 76.324 | 0.10994 | -34.621 | 0.04725 | 174.366 |
| 2750 | 0.12606 | 79.687 | 4.58063 | 74.605 | 0.10994 | -35.444 | 0.05010 | 167.162 |
| 2800 | 0.12922 | 78.399 | 4.55022 | 72.881 | 0.11034 | -36.246 | 0.05315 | 160.781 |
| 2850 | 0.13144 | 77.016 | 4.51863 | 71.172 | 0.11063 | -37.03 | 0.05620 | 154.624 |
| 2900 | 0.13428 | 75.734 | 4.49057 | 69.495 | 0.11089 | -37.754 | 0.06004 | 149.451 |
| 2950 | 0.13713 | 74.325 | 4.45366 | 67.734 | 0.11109 | -38.64 | 0.06342 | 144.065 |
| 3000 | 0.13914 | 72.892 | 4.42536 | 66.061 | 0.11140 | -39.407 | 0.06743 | 138.972 |
| 3050 | 0.14320 | 71.422 | 4.39730 | 64.387 | 0.11161 | -40.164 | 0.07181 | 134.77 |
| 3100 | 0.14613 | 70.248 | 4.36561 | 62.698 | 0.11191 | -40.968 | 0.07596 | 130.079 |
| 3150 | 0.14898 | 69.069 | 4.33420 | 61.007 | 0.11211 | -41.861 | 0.08043 | 125.992 |
| 3200 | 0.15264 | 67.768 | 4.30556 | 59.316 | 0.11252 | -42.74 | 0.08543 | 122.138 |
| 3250 | 0.15656 | 66.632 | 4.27446 | 57.648 | 0.11258 | -43.528 | 0.09047 | 117.963 |
| 3300 | 0.15948 | 65.655 | 4.24479 | 55.984 | 0.11281 | -44.448 | 0.09540 | 114.29 |
| 3350 | 0.16325 | 64.574 | 4.21546 | 54.301 | 0.11317 | -45.247 | 0.10082 | 110.967 |
| 3400 | 0.16694 | 63.679 | 4.18743 | 52.638 | 0.11329 | -46.134 | 0.10661 | 107.412 |
| 3450 | 0.17113 | 62.876 | 4.15740 | 50.961 | 0.11352 | -46.992 | 0.11195 | 104.192 |
| 3500 | 0.17493 | 62.049 | 4.12688 | 49.288 | 0.11374 | -47.856 | 0.11808 | 101.204 |
| 3550 | 0.17906 | 61.193 | 4.09892 | 47.63 | 0.11391 | -48.768 | 0.12404 | 98.182 |
| 3600 | 0.18310 | 60.522 | 4.06981 | 45.971 | 0.11410 | -49.604 | 0.13009 | 95.337 |

LIFE TIME BUY

LAST ORDER 24 MAY 14 LAST SHIP 24 MAY 15



- NOTES:
1. THERMAL AND RF GROUNDING CONSIDERATIONS SHOULD BE USED IN PCB LAYOUT DESIGN.
 2. DEPENDING ON PCB DESIGN RULES, AS MANY VIAS AS POSSIBLE SHOULD BE PLACED ON THE LANDING PATTERN.
 3. IF VIAS CANNOT BE PLACED ON THE LANDING PATTERN, THEN AS MANY VIAS AS POSSIBLE SHOULD BE PLACED AS CLOSE TO THE LANDING PATTERN AS POSSIBLE FOR OPTIMAL THERMAL AND RF PERFORMANCE.
 4. RECOMMENDED VIA PATTERN SHOWN HAS 0.381 x 0.762 MM PITCH.

Figure 20. Recommended Mounting Configuration

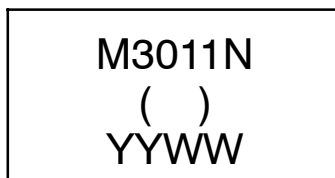
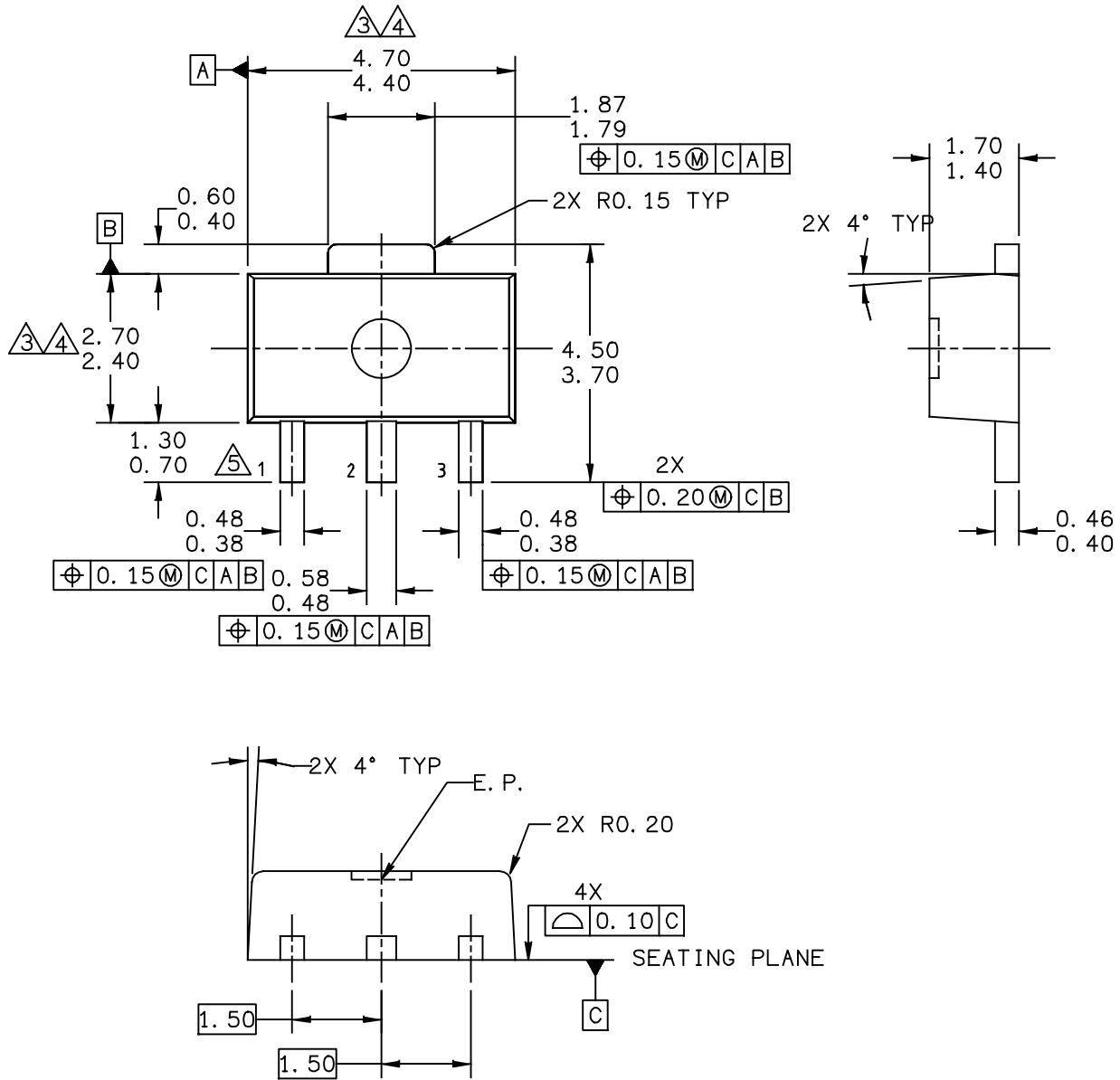
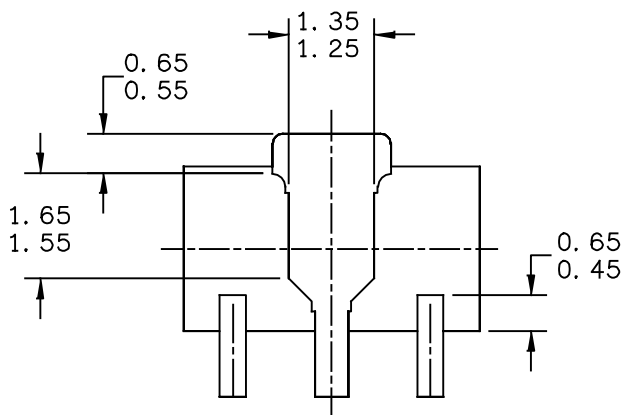


Figure 21. Product Marking

PACKAGE DIMENSIONS



| | | |
|--|--------------------------|----------------------------|
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICAL OUTLINE | PRINT VERSION NOT TO SCALE |
| TITLE: SOT-89, 4 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | DOCUMENT NO: 98ASA10586D | REV: D |
| | CASE NUMBER: 1514-02 | 27 JUN 2007 |
| | STANDARD: NON-JEDEC | |



BOTTOM VIEW

CASE STYLE:

STYLE 1:

PIN 1. RF INPUT
 PIN 2. GROUND
 PIN 3. RF OUTPUT

STYLE 2:

PIN 1. GATE
 PIN 2. SOURCE
 PIN 3. DRAIN

| | | | | | |
|--|--|--------------------------|--|----------------------------|--|
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | | MECHANICAL OUTLINE | | PRINT VERSION NOT TO SCALE | |
| TITLE: SOT-89, 4 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | | DOCUMENT NO: 98ASA10586D | | REV: D | |
| | | CASE NUMBER: 1514-02 | | 27 JUN 2007 | |
| | | STANDARD: NON-JEDEC | | | |

NOTES:

1 DIMENSIONING AND TOLERANCING PER ASME Y14.5M – 1994.

2 ALL DIMENSIONS ARE IN MILLIMETERS.

3 DIMENSIONS DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5mm PER END. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5 mm PER SIDE.

4 DIMENSION ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

5 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

| | | | |
|--|--------------------------|----------------------------|--|
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| TITLE: SOT-89, 4 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | DOCUMENT NO: 98ASA10586D | REV: D | |
| | CASE NUMBER: 1514-02 | 27 JUN 2007 | |
| | STANDARD: NON-JEDEC | | |

Refer to the following resources to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers
- AN3100: General Purpose Amplifier and MMIC Biasing

Software

- .s2p File

Development Tools

- Printed Circuit Boards

For Software and Tools, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to Software & Tools on the part’s Product Summary page to download the respective tool.

REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date | Description |
|----------|------------|---|
| 3 | Mar. 2007 | <ul style="list-style-type: none"> • Corrected and updated Part Numbers in Tables 8 and 9, Component Designations and Values, to RoHS compliant part numbers, pp. 6, 7 |
| 4 | July 2007 | <ul style="list-style-type: none"> • Replaced Case Outline 1514-01 with 1514-02, Issue D, pp. 1, 11-13. Case updated to add missing dimension for Pin 1 and Pin 3. |
| 5 | Mar. 2008 | <ul style="list-style-type: none"> • Removed Footnote 2, Continuous voltage and current applied to device, from Table 2, Maximum Ratings, p. 1 • Corrected Fig. 13, Single-Carrier W-CDMA Adjacent Channel Power Ratio versus Output Power y-axis (ACPR) unit of measure to dBc, p. 5 • Corrected S-Parameter table frequency column label to read “MHz” versus “GHz” and corrected frequency values from GHz to MHz, pp. 8, 9 |
| 6 | Feb. 2012 | <ul style="list-style-type: none"> • Corrected temperature at which Theta_{JC} is measured from 25°C to 87°C and added “no RF applied” to Thermal Characteristics table to indicate that thermal characterization is performed under DC test with no RF signal applied, p. 1 • Table 6, ESD Protection Characterization, removed the word “Minimum” after the ESD class rating. ESD ratings are characterized during new product development but are not 100% tested during production. ESD ratings provided in the data sheet are intended to be used as a guideline when handling ESD sensitive devices, p. 3 • Removed I_{CC} bias callout from applicable graphs and Table 10, Common Emitter S-Parameters heading as bias is not a controlled value, pp. 4-9 • Added .s2p File availability to Product Software and Printed Circuit Boards to Development Tools, p. 14 |
| 7 | Sept. 2014 | <ul style="list-style-type: none"> • Added Fig. 21, Product Marking, p. 9 |

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